onsemi

MOSFET – N-Channel, POWERTRENCH[®]

60 V

FDS5680

General Description

This N-Channel MOSFET is produced using **onsemi**'s advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

Features

- S A, -60 V. $R_{DS(ON)} = 0.020 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$ $R_{DS(ON)} = 0.025 \text{ m}\Omega @ V_{GS} = 6 \text{ V}$
- Low Gate Charge (30 nC typical)
- Fast Switching Speed
- High Performance Trench Technology for Extremely Low RDS(ON)
- High Power and Current Handling Capability
- These Device is Pb–Free and Halide Free

Applications

- dc-dc Converter
- Load Switch
- Motor Drives

ABSOLUTE MAXIMUM RATINGS $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Value	Unit	
V _{DSS}	Drain-Source Voltage	60	V	
V _{GSS}	Gate-Source Voltage	±20	V	
Ι _D	Drain Current – Continuous (Note 1a) – Pulsed	8 50	А	
PD	Power Dissipation for Single Operation (Note 1a) (Note 1b) (Note 1c)	2.5 1.2 1	W	
T _J , T _{stg}	Operating and Storage Junction Temperature Range	–55 to +150	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Value	Unit	
R _{θJA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W	
R _{θJC}	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W	

V _{DSS}	R _{DS(on)} MAX	I _D MAX
–60 V	0.020 mΩ @ 10 V	S A
	0.025 mΩ @ 6 V	



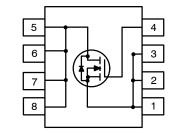
MARKING DIAGRAM



FDS5680 = Specific Device Code

- \$Y = onsemi Logo
- &Z = Assembly Location
- &2 = Date Code
- &K = Lot Run Traceability Code

PIN ASSIGNMENT



ORDERING INFORMATION

Device	Package	Shipping [†]
FDS5680	SOIC8 CASE 751EB (Pb–Free)	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

FDS5680

ELECTRICAL CHARACTERISTICS $T_A = 25^{\circ}C$ unless otherwise noted

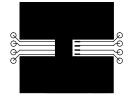
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS			-	-	-
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	60	-	-	V
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta \text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu A$, Referenced to $25^{\circ}C$	_	27	_	mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 48 V, V_{GS} = 0 V$	-	-	1	μA
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	-	-	100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	-	-	-100	nA
ON CHARA	CTERISTICS (Note 2)	-		-	-	-
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2	2.5	4	V
$\frac{\Delta V_{\text{GS(th)}}}{\Delta T_{\text{J}}}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25° C	-	-4.5	-	mV/°C
R _{DS(on)}	Static Drain-Source On-Resistance	$ \begin{array}{l} V_{GS} = 10 \; V, I_D = 8 \; A \\ V_{GS} = 10 \; V, \; I_D = 8 \; A, \; T_J = 125^\circ C \\ V_{GS} = 6 \; V, \; I_D = 7.5 \; A \end{array} $		0.017 0.027 0.019	0.020 0.032 0.025	Ω
I _{D(on)}	On-State Drain Current	V_{GS} = 10 V, V_{DS} = 5 V	25	-	-	А
9 _{FS}	Forward Transconductance	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	-	28	-	mS
DYNAMIC C	HARACTERISTICS					
C _{iss}	Input Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V,$	-	1850	-	pF
C _{oss}	Output Capacitance	f = 1.0 MHz	-	290	-	pF
C _{rss}	Reverse Transfer Capacitance		-	100	-	pF
SWITCHING	CHARACTERISTICS (Note 2)					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 30 \text{ V}, \text{ I}_{D} = 1 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$	-	13	24	ns
t _r	Turn–On Rise Time		-	8	16	ns
t _{d(off)}	Turn-Off Delay Time		-	16	26	ns
t _f	Turn-Off Fall Time		-	32	50	ns
Qg	Total Gate Charge	$V_{DD} = 15 \text{ V}, \text{ I}_{D} = 8 \text{ A}, V_{GS} = 10 \text{ V}$	-	30	42	nC
Q _{gs}	Gate-Source Charge		-	8.5	-	nC
Q _{gd}	Gate-Drain Charge		-	5.5	_	nC
	JRCE DIODE CHARACTERISTICS AND MAXIM	UM RATINGS				
IS	Maximum Continuous Drain-Source Diode Forward Current		-	-	2.1	Α

 V_{SD} Drain-Source Diode Forward Voltage $V_{GS} = 0 \text{ V}, I_S = 2.1 \text{ A}$ (Note 2)-0.741.2VProduct parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

NOTES:

1. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a) 50° C/W when mounted on a 0.5 in² pad of 2 oz copper.



b) 105° C/W when mounted on a 0.02 in² pad of 2 oz copper.



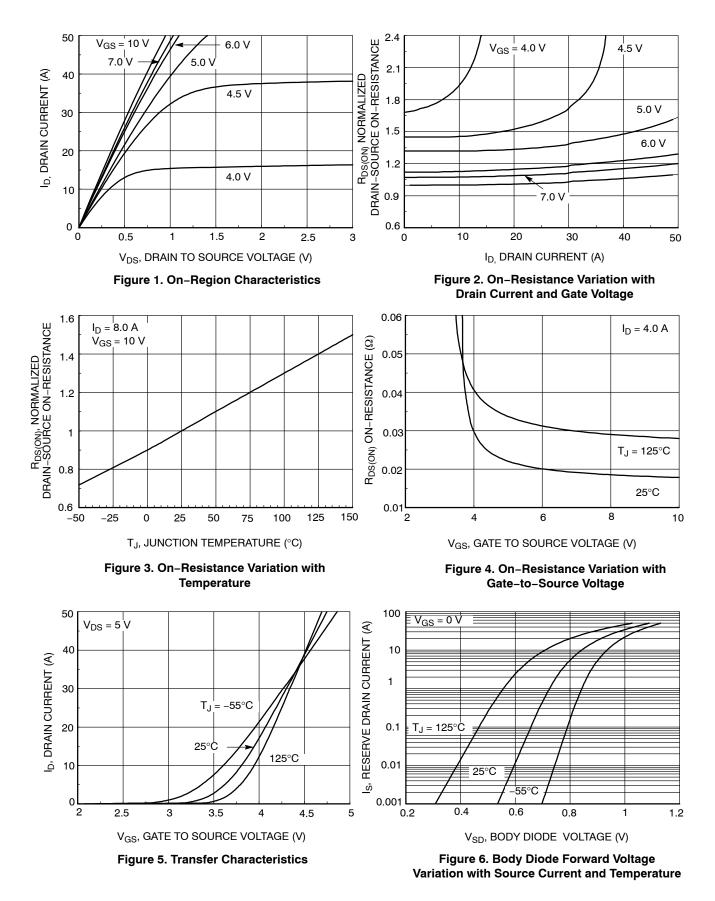
b) 125°C/W when mounted on a minimum pad.

Scale 1:1 on letter size paper

2. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

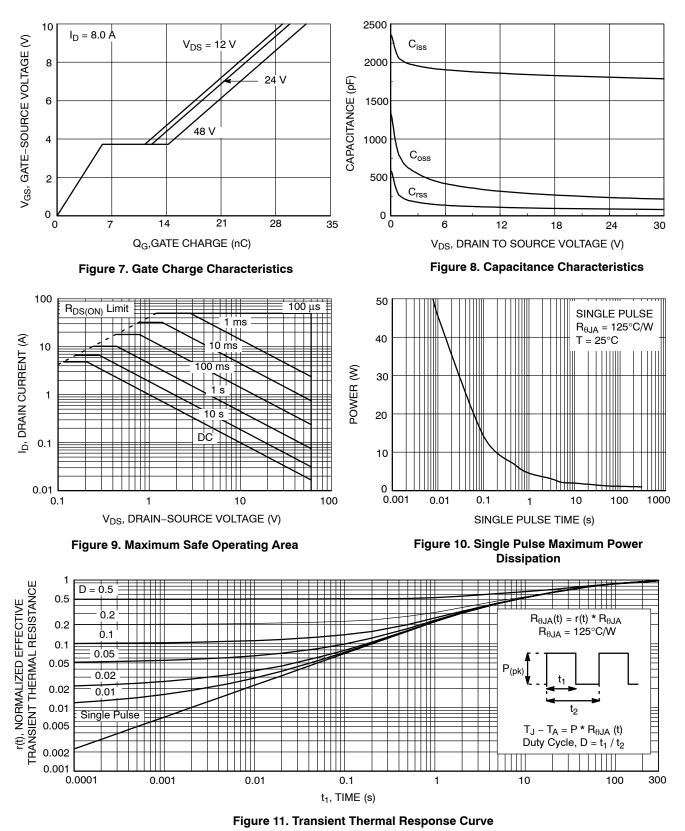
FDS5680

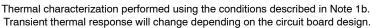
TYPICAL CHARACTERISTICS



FDS5680

TYPICAL CHARACTERISTICS (continued)

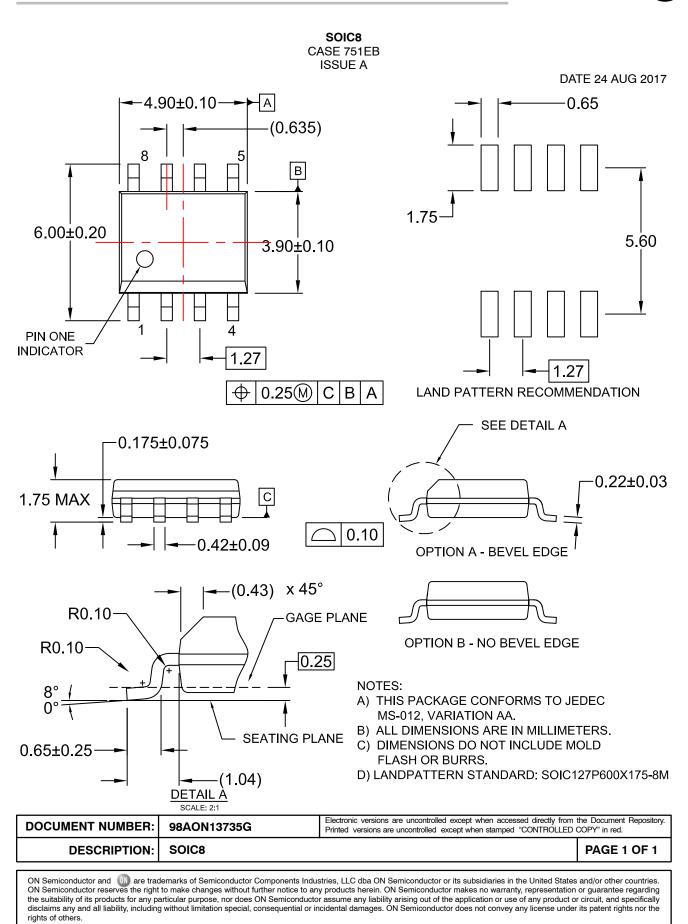




POWERTRENCH is registered trademark of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries.

FDS5680





© Semiconductor Components Industries, LLC, 2019

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and calcular performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative